

	Search Text	DBs
1	dielectric same heating same teflon same microwave	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
2	dielectric same heating same teflon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
3	3 and teflon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
4	dielectric same heating same susceptor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
5	(microwave or radio-frequency or rf or dielectric) same heating same susceptor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
6	5 and teflon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
7	(microwave or radio-frequency or rf or dielectric) same (sinter\$3 or heat\$3) same susceptor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
8	7 and teflon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
9	(microwave or radio-frequency or rf or dielectric) same (sinter\$3 or heat\$3 or weld\$3 or seal\$3) same susceptor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
10	(microwave or radio-frequency or rf or dielectric) same (sinter\$3 or heat\$3 or weld\$3 or seal\$3) same susceptor same teflon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
11	9 and teflon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
12	teflon near5 (weld\$3 or seal\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB

	Search Text	DBs
13	teflon near2 (weld\$3 or seal\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
14	(teflon near2 (weld\$3 or seal\$3)) same (loss near5 (tangent or factor))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
15	(teflon near2 (weld\$3 or seal\$3)) same (microwave or dielectric)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
16	teflon near5 sintering	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
17	(microwave or radio-frequency or rf or dielectric) same (sinter\$3 or heat\$3 or weld\$3 or seal\$3) same teflon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
18	(microwave or radio-frequency or rf or dielectric) same (sinter\$3 or heat\$3 or weld\$3 or seal\$3) same teflon same susceptor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
19	((polytetrafluoroethylene or teflon) near5 sintering) same susceptor same (dielectric or microwave)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
20	((polytetrafluoroethylene or teflon) near5 sintering) and (susceptor same (dielectric or microwave))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
21	((polytetrafluoroethylene or teflon) near5 sintering)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
22	21 and vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
23	21 and (vacuum same (pore or porosity or porous))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
24	21 and (vacuum near5 heat\$3) and (pore or porosity or porous)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB

	Search Text	DBs
25	(microwave or radio-frequency or rf or dielectric) same (sinter\$3 or heat\$3 or weld\$3 or seal\$3) same vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
26	27 and (vacuum same (pore or porosity or porous))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
27	28 and (polytetrafluoroethylene or teflon)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
28	(teflon or polytetrafluoroethylene) and (dielectric or microwave or radio-frequency or rf) and sinter\$3	USOCR; FPRS
29	(teflon or polytetrafluoroethylene) and (dielectric or microwave or radio-frequency or rf) and sinter\$3 and vacuum	USOCR; FPRS
30	(rubber same nitrile same porous) same (teflon or polytetrafluoroethylene)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB
31	(rubber same nitrile same porous same membrane) same (teflon or polytetrafluoroethylene)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB
32	(microwave or radio-frequency or rf or dielectric) same (sinter\$3 or heat\$3 or weld\$3 or seal\$3) same vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
33	(microwave or radio-frequency or rf or dielectric) same sinter\$3 same vacuum same porous	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
34	teflon same sinter\$3 same vacuum same porous	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
35	teflon same sinter\$3 same vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

36	sintering near5 vacuum near5 teflon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
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	Search Text	DBs
37	(264/125,126,127).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
38	45 and 46	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
39	46 and vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
40	46 and (vacuum near5 sintering)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
41	(264/101,102).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
42	46 and 52	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
43	(264/491,489,490).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
44	46 and (vacuum near5 heat\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
45	45 and sinter\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
46	55 and vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB